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TRPGP40ATGC

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Datasheet of TRPGP40ATGC - IC TRANSPONDER CCT 12MM TGC

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TRPGP40ATGC

SCBS903 - AUGUST 2014

TRPGP40ATGC 12-mm Low-Frequency Glass-Encapsulated Transponder, CCT

1 Device Overview

1.1 Features

- Best-in-Class Performance Through Patented HDX Technology
- Patented Transponder Tuning Provides Stable and High Read Performance
- 80-Bit Customer-Configurable Transponder (CCT)
 Type
- Insensitive to Almost All Nonmetallic Materials

1.2 Applications

Animal ID

1.3 Description

Texas Instruments' 12-mm low-frequency (LF) glass transponders provide superior performance and operate at a resonance frequency of 134.2 kHz. The products are compliant to ISO/IEC 11784 and ISO/IEC 11785 global open standards. Texas Instruments LF glass transponders are manufactured with TI's patented tuning process to provide consistent read performance. Before delivery, the transponders undergo complete functional and parametric testing to provide the high quality customers have come to expect from TI.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)(2)		
TRPGP40ATGC	TGC (0)	2.12 mm x 12.0 mm		

⁽¹⁾ For the most current device, package, and ordering information, see the Package Option Addendum in Section 5, or see the TI web site at www.ti.com.

Figure 1-1 shows the transponder.



Figure 1-1. TRPGP40ATGC Transponder

⁽²⁾ The sizes shown here are approximations. For the package dimensions with tolerances, see the Mechanical Data in Section 5.



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2 Revision History

DATE	REVISION	NOTES		
August 2014	*	Initial Release		



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3 Specifications

3.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

1 0	,			
		MIN	MAX	UNIT
T _A	Operating temperature range	-25	70	°C

3.2 Handling Ratings

		MIN	MAX	UNIT
T _{STG}	Storage temperature range	-40	85	°C

3.3 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TRPGP40ATGC
Functionality	Not programmed
Memory (bits)	80
Memory (pages)	1
Resonance frequency	134.6 kHz
Modulation	FSK (frequency shift keying) 134.2 kHz and 124.2 kHz
Transmission principle	HDX (half duplex)
Power source	Powered from the reader signal (battery-less)
Typical reading range	≤60 cm ⁽¹⁾
Typical reading time	70 ms
Case material	Glass
Protection glass	Hermetically sealed
EMC	Programmed code is not affected by natural electromagnetic interference or x-rays
Signal penetration	Transponder can be read through almost all nonmetallic material
Mechanical shock	IEC 60068-2-32 free-fall drop test, 20 times from 1.5-m height
Dimensions	Ø 2.12 ± 0.05 mm x 12.0 ± 0.5 mm
Weight	0.10 g

(1) Depends on RF regulation in country of use, the reader antenna configuration used, and the environmental conditions.

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4 Device and Documentation Support

4.1 Documentation Support

The following documents describe the TRPGR30ATGC device. Copies of these documents are available on the Internet at www.ti.com.

SPAT178

RFID Systems Product Specifications. Texas Instruments Radio Frequency Identification Systems is an industry leader in RFID technology, and the world's largest integrated manufacturer of TI-RFid™ tags, TI-RFid smart labels, and TI-RFid reader systems. With more than 1 billion RFID tags manufactured, TI-RFid technology is used in a broad range of RFID applications worldwide. TI is an active member of many standards bodies, including ISO, ISO/IEC, ECMA International, ETSI, and several national standardization bodies working to drive the adoption of global standards for RFID technology.

SPAT184

12mm Glass Encapsulated HDX Transponders. Product bulletin that provides an overview of the features of the glass encapsulated transponders from TI.

4.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

4.3 Trademarks

TI-RFid, E2E are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

4.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

4.5 Export Control Notice

Recipient agrees to not knowingly export or re-export, directly or indirectly, any product or technical data (as defined by the U.S., EU, and other Export Administration Regulations) including software, or any controlled product restricted by other applicable national regulations, received from Disclosing party under this Agreement, or any direct product of such technology, to any destination to which such export or reexport is restricted or prohibited by U.S. or other applicable laws, without obtaining prior authorization from U.S. Department of Commerce and other competent Government authorities to the extent required by those laws.

4.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

5 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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PACKAGE OPTION ADDENDUM

29-Jul-2015

PACKAGING INFORMATION

Orderable Device	Status	Package Type	e Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
TRPGP40ATGC	ACTIVE	RFIDT	TGC	0	2000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
- (6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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